



ZXTR2008Z

100V INPUT, 8.2V 30mA REGULATOR TRANSISTOR

Description

The ZXTR2008Z monolithically integrates a transistor, Zener diode and resistor to function as a high voltage linear regulator. The device regulates with an 8.2V nominal output at 15mA. It is designed for use in high voltage applications where standard linear regulators cannot be used. This function is fully integrated into a SOT89 package, minimizing PCB area and reducing number of components when compared with a multi-chip discrete solution.

Applications

Supply Voltage Regulation in:

- Startup Switch in DC-DC Converters
- Networking
- Telecommunications
- Power over Ethernet (PoE)

SOT89 V_{IN} Top View Top View Liternal Device

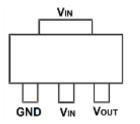
Schematic

Features

- Series Linear Regulator Using Emitter-Follower Stage
- Input Voltage = 12V to 100V (For Regulated Output Voltage)
- Output Voltage = 8.2V ± 10%
- 150kΩ Resistor to Limit Quiescent Current
- Fully Integrated into a SOT89 package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 for High Reliability

Mechanical Data

- Case: SOT89
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208
- Weight: 0.052 grams (Approximate)



Pin Name	Pin Function
VIN	Input Supply
GND	Power Ground
Vout	Voltage Output



Ordering Information (Note 4)

Product	Package	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
ZXTR2008Z-7	SOT89	1S4	7	12	1,000
ZXTR2008Z-13	SOT89	1S4	13	12	2,500

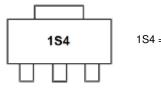
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.

3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



1S4 = Product Type Marking Code



Absolute Maximum Ratings (Voltage relative to GND, @TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Input Voltage	VIN	-0.3 to 100	V
Continuous Input & Output Current	Iin, Iout	400	mA
Peak Pulsed Input & Output Current	I _{IM} , I _{OM}	2	А
Maximum Voltage applied to VOUT	V _{OUT(MAX)}	Smaller of V _{IN} +8.2V or 14.5V	V

Maximum Current at V_{IN} = 48V (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Continuous Output Current	(Note 7)	lout	42	mA
Pulsed Output Current	(Note 8)		800	m A
Puised Output Current	(Note 9)	IOM	160	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Power Dissinction	(Note 5)		1.7	W
Power Dissipation	(Note 6)	P _D	0.89	vv
Thermal Desistance, Junction to Ambient	(Note 5)		59	
Thermal Resistance, Junction to Ambient	(Note 6)	R _{0JA}	112	
Thermal Resistance, Junction to Lead	(Note 10)	R _{θJL}	20	°C/W
Thermal Resistance, Junction to Case (N		R _{θJC}	15.7	
Recommended Operating Junction Temperature	TJ	-40 to +125	°C	
Maximum Operating Junction and Storage Temperature Range		T _J , T _{STG}	-65 to +150	°C

ESD Ratings (Note 11)

Characteristics	Symbols	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge – Machine Model	ESD MM	400	V	С

Notes: 5. For a device mounted with the exposed V_{IN} pad on 50mm x 50mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.

6. Same as Note 5, except mounted on 15mm x 15mm 1oz copper.

7. Same as Note 5, whilst operating at V_{IN} = 48V. Refer to Safe Operating Area for other Input Voltages.

8. Same as Note 5, except measured with a single pulse width = 100 μs and V $_{IN}$ = 48V.

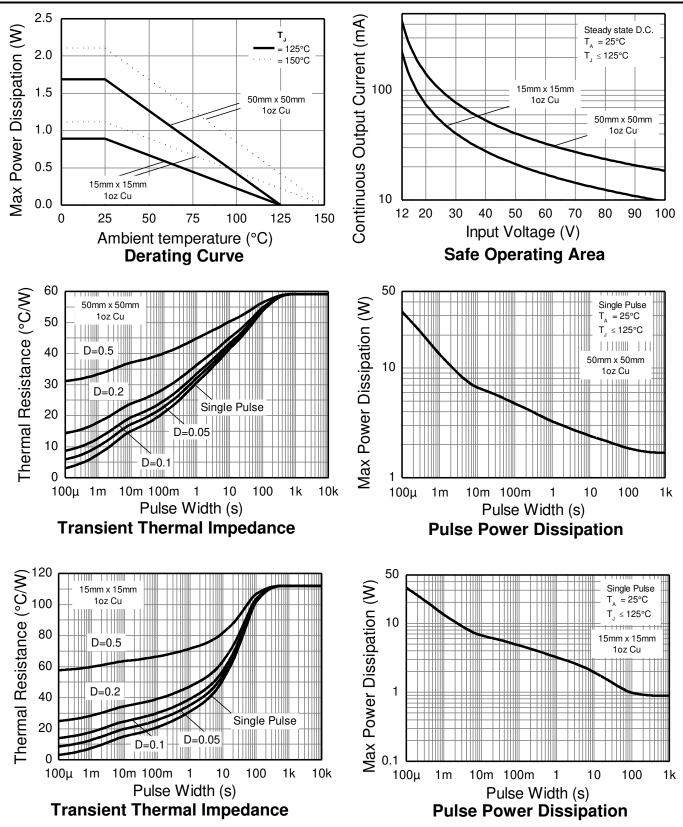
9. Same as Note 5, except measured with a single pulse width = 10ms and V_{IN} = 48V.

10. $R_{\theta JL}$ = Thermal resistance from junction to solder-point (on the exposed V_{IN} pad). $R_{\theta JC}$ = Thermal resistance from junction to the top of case.

11. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Output Voltage (Note 12)	Vout	7.38	8.2	9.02	V	$V_{IN} = 48V, I_{OUT} = 15mA$
Line Regulation (Notes 12 & 13)	ΔV_{OUT}	_	10	300	mV	V _{IN} = 12 to 100V, I _{OUT} = 15mA
Temperature Coefficient	$\Delta V_{OUT} / \Delta T$	_	10	—	mV/°C	$ T_J = -40^{\circ}C \text{ to } +125^{\circ}C $ $ V_{IN} = 48V, I_{OUT} = 15mA $
Load Regulation (Notes 12 & 14)	ΔV _{OUT}	—	-180 -250	-350 -500	mV	I _{OUT} = 0.1 to 30mA, V _{IN} = 48V I _{OUT} = 0.1 to 100mA, V _{IN} = 48V
Minimum Value of Input Voltage Required to Maintain Line Regulation	VIN(MIN)	12	_	_	V	—
Quiescent Current	Ι _Q	—	275 650	500 900	μA	V _{IN} = 48V, I _{OUT} = 10μA V _{IN} = 100V, I _{OUT} = 10μA
Power Supply Rejection Ratio	$\Delta V_{\text{IN}} / \Delta V_{\text{OUT}}$		38	_	dB	$C_{OUT} = 100$ nF, $I_{OUT} = 15$ mA, $V_{OUT} = 8.2$ V, $V_{IN} = 12$ to 100V,f=100Hz

Notes: 12. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%

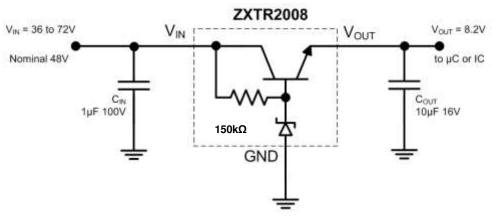
13. Line regulation $\Delta V_{OUT} = V_{OUT} (@V_{IN} = 100V) - V_{OUT} (@V_{IN} = 12V)$

14. Load regulation ΔV_{OUT}

tion $\Delta V_{OUT} = V_{OUT} (@ I_{OUT} = 30mA) - V_{OUT} (@ I_{OUT} = 0.1mA)$

 $\Delta V_{OUT} = V_{OUT}(@ I_{OUT} = 100mA) - V_{OUT}(@ I_{OUT} = 0.1mA)$

Typical Application Circuit



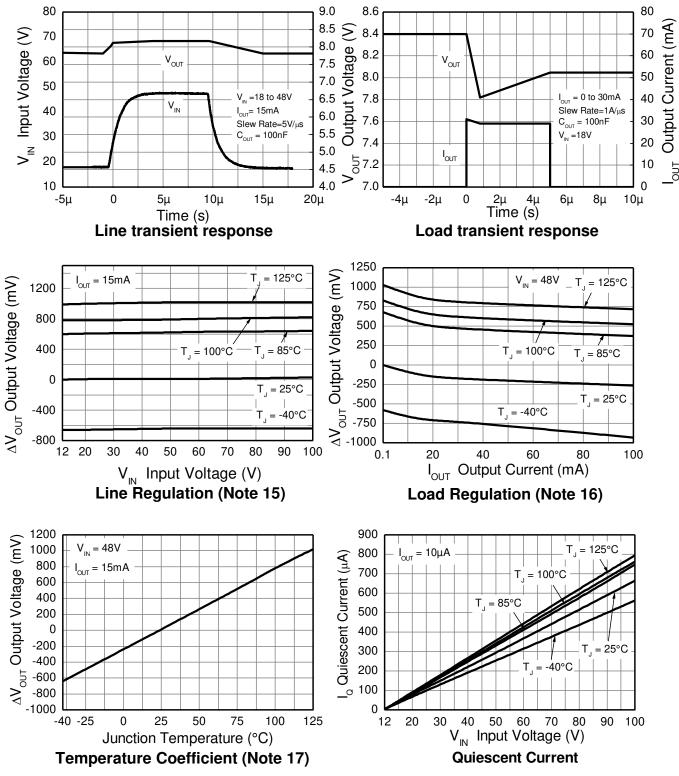
Example of an 8.2V regulated supply from a nominal 48V for powering a Controller IC.

Pin Func	tions	
Pin Name	Pin Function	Notes
V _{IN}	Input Supply	Input voltage can vary from -0.3V to 100V with respect to GND; for V_{OUT} regulated then $12V \le V_{IN} \le 100V$. It is recommended to connect a 1µF capacitor to GND.
GND	Power Ground	This pin should be tied to the system ground.
Vouт	Voltage Output	Outputs a regulated 8V when $12V \le V_{IN} \le 100V$. When $V_{IN} < 12V$, then V_{OUT} maximum = $V_{IN} - 1.5V$. The pin can be pulled high to a maximum of +14V with respect to GND, or +8V with respect to V_{IN} , whichever is lower. It is recommended to connect a 10μ F capacitor to GND and a minimum of 10μ A to be drawn from V_{OUT} to maintain regulation.

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Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)



Notes: 15. Line regulation $\Delta V_{OUT} = V_{OUT} - V_{OUT}$ (@ V_{IN} = 12V, I_{OUT} = 15mA, T_J = +25°C)

16. Load regulation $\Delta V_{OUT} = V_{OUT} - V_{OUT}$ (@ V_{IN} = 48V, I_{OUT} = 0.1mA, T_J = +25°C)

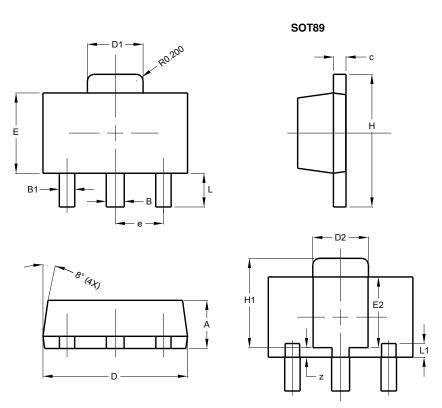
17. Temperature Coefficient $\Delta V_{OUT} = V_{OUT} - V_{OUT}$ (@ VIN = 48V, I_{OUT} = 15mA, T_J = +25°C)

ZXTR2008Z



Package Outline Dimensions

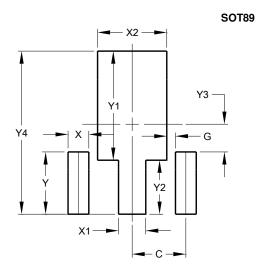
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT89						
Dim	Min	Max	Тур			
Α	1.40	1.60	1.50			
в	0.50	0.62	0.56			
B1	0.42	0.54	0.48			
c	0.35	0.43	0.38			
D	4.40	4.60	4.50			
D1	1.62	1.83	1.733			
D2	1.61	1.81	1.71			
Е	2.40	2.60	2.50			
E2	2.05	2.35	2.20			
e	-	-	1.50			
Η	3.95	4.25	4.10			
H1	2.63	2.93	2.78			
L	0.90	1.20	1.05			
L1	0.327	0.527	0.427			
z	0.20	0.40	0.30			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value
Dimensions	(in mm)
С	1.500
G	0.244
Х	0.580
X1	0.760
X2	1.933
Y	1.730
Y1	3.030
Y2	1.500
Y3	0.770
Y4	4.530



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